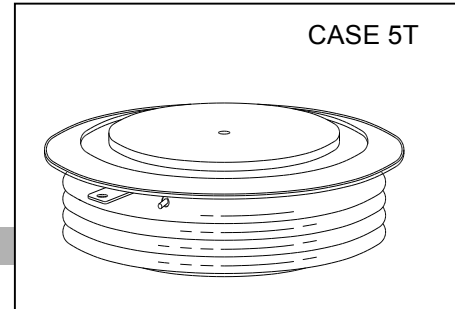


KP5000A

HIGH POWER THYRISTOR FOR PHASE CONTROL APPLICATIONS

Features:

- . All Diffused Structure
- . Spoke Amplifying Gate Configuration
- . Guaranteed Maximum Turn-Off Time
- . High dV/dt Capability
- . Pressure Assembled Device



ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking - Off State

| Device Type | V _{RRM} (1) | V _{DRM} (1) | V _{RSM} (1) |
|-------------|----------------------|----------------------|----------------------|
| KP5000 | 2500 | 2500 | 2700 |
| KP5000 | 2800 | 2800 | 3000 |
| KP5000 | 3000 | 3000 | 3200 |

V_{RRM} = Repetitive peak reverse voltage
V_{DRM} = Repetitive peak off state voltage
V_{RSM} = Non repetitive peak reverse voltage (2)

| | | |
|---|-------------------------------------|--------------------|
| Repetitive peak reverse leakage and off state leakage | I _{RRM} / I _{DRM} | 20 mA 300mA (3) |
| Critical rate of voltage rise | dV/dt (4) | 1000V/μsec |

Notes:

All ratings are specified for T_j=25 °C unless otherwise stated.

- (1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range -40 to +125 °C.
- (2) 10 msec. max. pulse width
- (3) Maximum value for T_j = 125 °C.
- (4) Minimum value for linear and exponential waveshape to 70% rated V_{DRM}. Gate open. T_j = 125 °C.
- (5) Non-repetitive value.
- (6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a 0.2 μF capacitor and 20 ohms resistance in parallel with the thyristor under test.

Conducting - on state

| Parameter | Symbol | Min. | Max. | Typ. | Units | Conditions |
|--|--------------------|------|----------------------|------|------------------|--|
| Average value of on-state current | I _{T(AV)} | | 5000 | | A | conduction, T _c =55°C |
| RMS value of on-state current | I _{TRMS} | | 7900 | | A | Nominal value |
| Peak one cycle surge (non repetitive) current | I _{TSM} | | 75000 | | A | 10.0 msec (50Hz), sinusoidal waveshape, 180° conduction, T _j = 125 °C |
| I square t | I ² t | | 2.8.x10 ⁶ | | A ² s | 10.0 msec |
| Latching current | I _L | | 3 | | A | V _D = 24 V; R _L = 12 ohms |
| Holding current | I _H | | 350 | | mA | V _D = 24 V; I = 2.5 A |
| Peak on-state voltage | V _{TM} | | 1.60 | | V | I _{TM} = 6000 A; Duty cycle ≤ 0.01% |
| Critical rate of rise of on-state current (5, 6) | di/dt | | 300 | | A/μs | Switching from V _{DRM} ≤ 3000 V, non-repetitive |
| Critical rate of rise of on-state current (6) | di/dt | | 150 | | A/μs | Switching from V _{DRM} ≤ 3000 V |

ELECTRICAL CHARACTERISTICS AND RATINGS (cont'd) Power Thyristor KP5000A**Gating**

| Parameter | Symbol | Min. | Max. | Typ. | Units | Conditions |
|--|-------------|------|------|------|-------|--|
| Peak gate power dissipation | P_{GM} | | 200 | | W | $t_p = 40 \mu s$ |
| Average gate power dissipation | $P_{G(AV)}$ | | 5 | | W | |
| Peak gate current | I_{GM} | | 20 | | A | |
| Gate current required to trigger all units | I_{GT} | | 300 | | mA | $V_D = 6 V; R_L = 3 \text{ ohms}; T_j = +25^\circ C$ |
| Gate voltage required to trigger all units | V_{GT} | | 3 | | V | $V_D = 6 V; R_L = 3 \text{ ohms}; T_j = 25^\circ C$ |
| Peak negative voltage | V_{GRM} | | 20 | | V | |

Dynamic

| Parameter | Symbol | Min. | Max. | Typ. | Units | Conditions |
|-------------------------------------|----------|------|------|------|---------|--|
| Delay time | t_d | | 3.0 | | μs | $I_{TM} = 50 A; V_D = 2000 V$ Gate pulse: $V_G = 20 V; R_G = 20 \text{ ohms};$ $t_r = 0.1 \mu s; t_p = 20 \mu s$ |
| Turn-off time (with $V_R = -50 V$) | t_q | | 700 | 400 | μs | $I_{TM} > 2000 A; di/dt = 10 A/\mu s;$ $V_R \geq -50 V; \text{Re-applied } dV/dt = 500$ $V/\mu s \text{ linear to } 2000 V; V_G = 0;$ $T_j = 125^\circ C; \text{Duty cycle } \geq 0.01\%$ |
| Reverse recovery current | I_{rr} | | 300 | | A | $I_{TM} > 2000 A; di/dt = 10 A/\mu s;$ $V_R \geq -50 V$ |

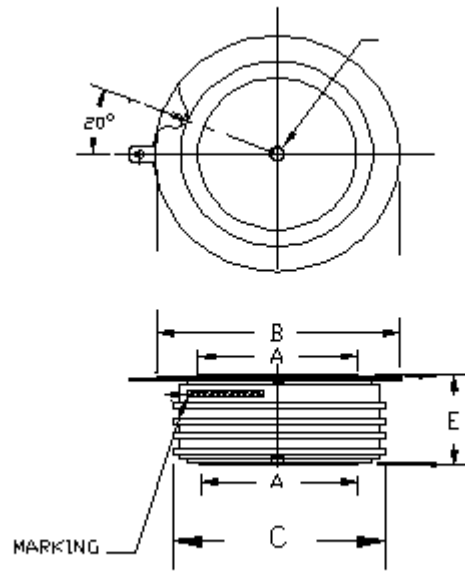
THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

| Parameter | Symbol | Min. | Max. | Typ. | Units | Conditions |
|---------------------------------------|-------------------|------|-------|------|--------------|----------------------------|
| Operating temperature | T_j | -40 | +125 | | $^\circ C$ | |
| Storage temperature | T_{stg} | -40 | +150 | | $^\circ C$ | |
| Thermal resistance - junction to case | $R_{\theta(j-c)}$ | | 0.006 | | $^\circ C/W$ | Double sided cooled |
| Thermal resistance - case to sink | $R_{\theta(c-s)}$ | | 0.002 | | $^\circ C/W$ | Double sided cooled * * |
| Mounting force | F | | 100 | | kN | |

* Mounting surfaces smooth, flat and

greased

Note : for case outline and dimensions, see case outline drawing in page 3 of this Technical Data



A: 100 mm

B: 142 mm

C: 131 mm

E: 35 mm